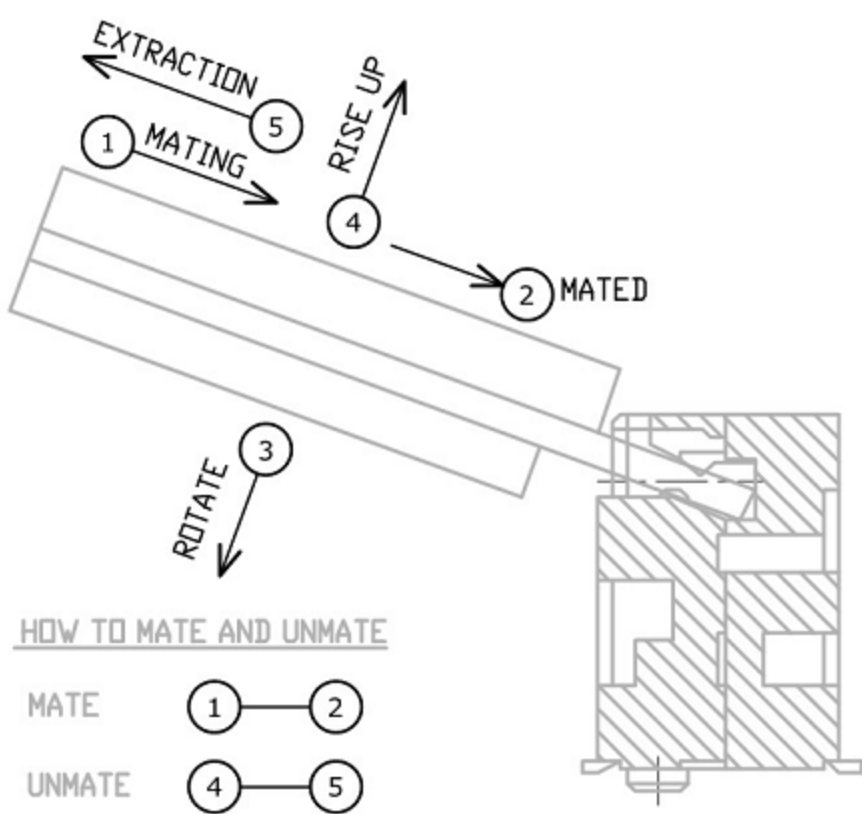
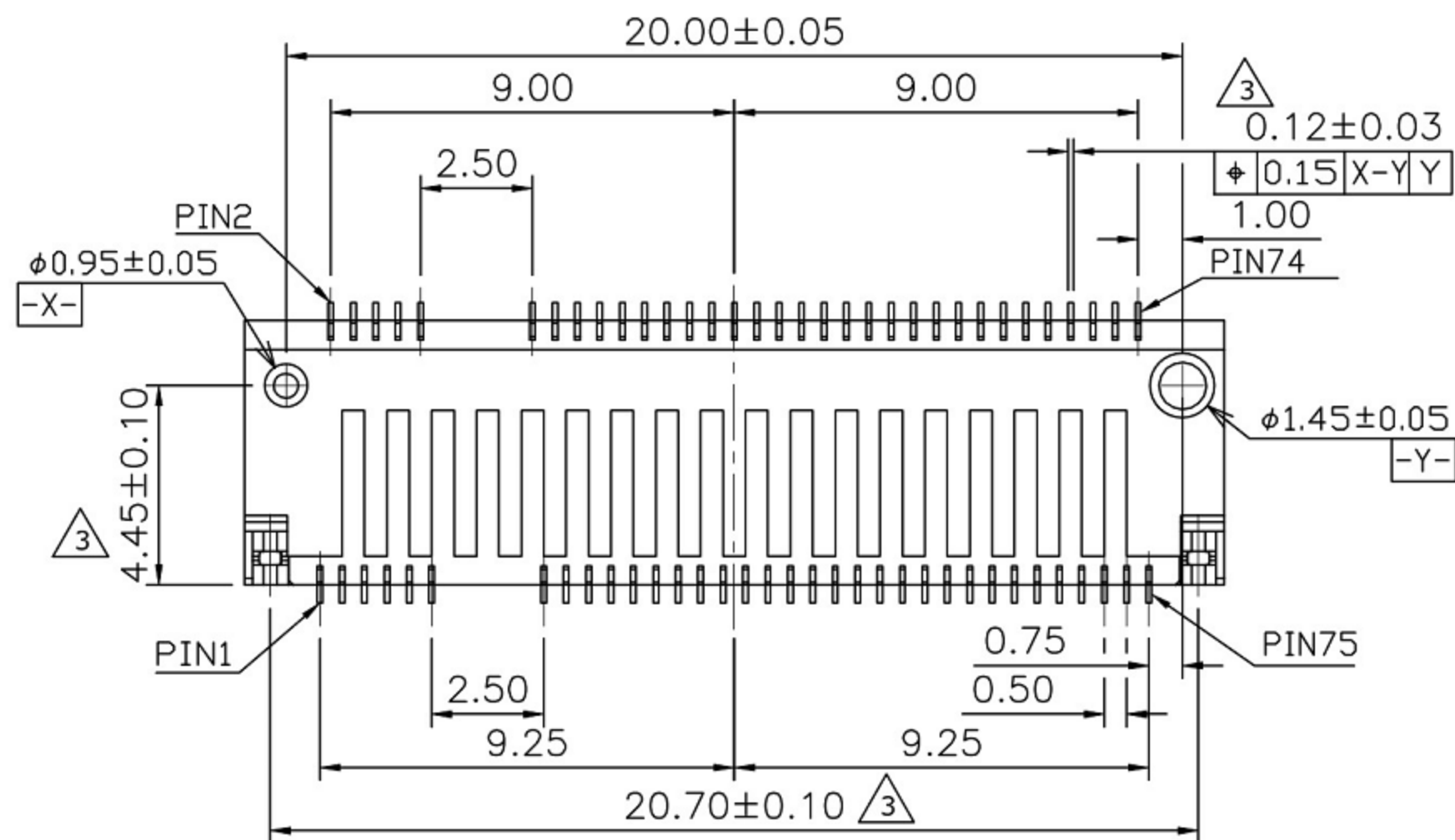
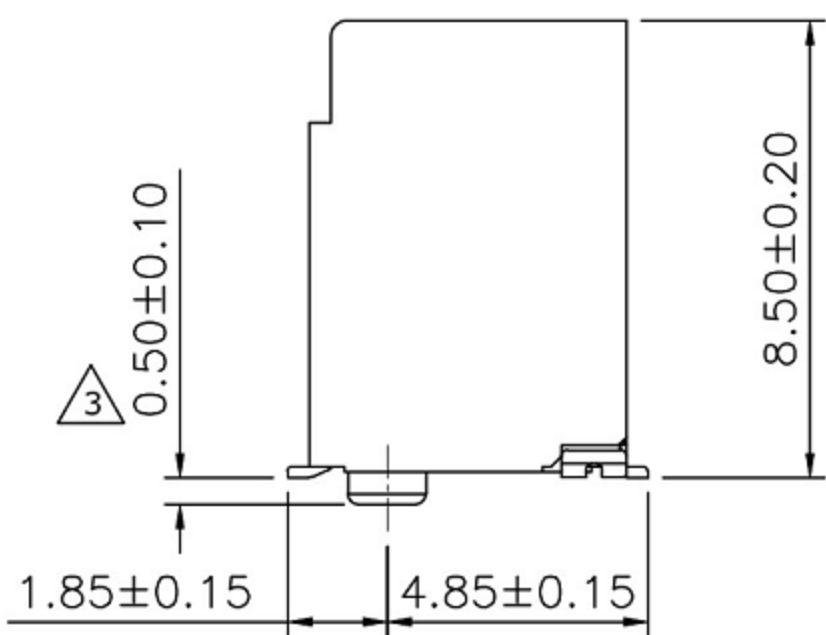
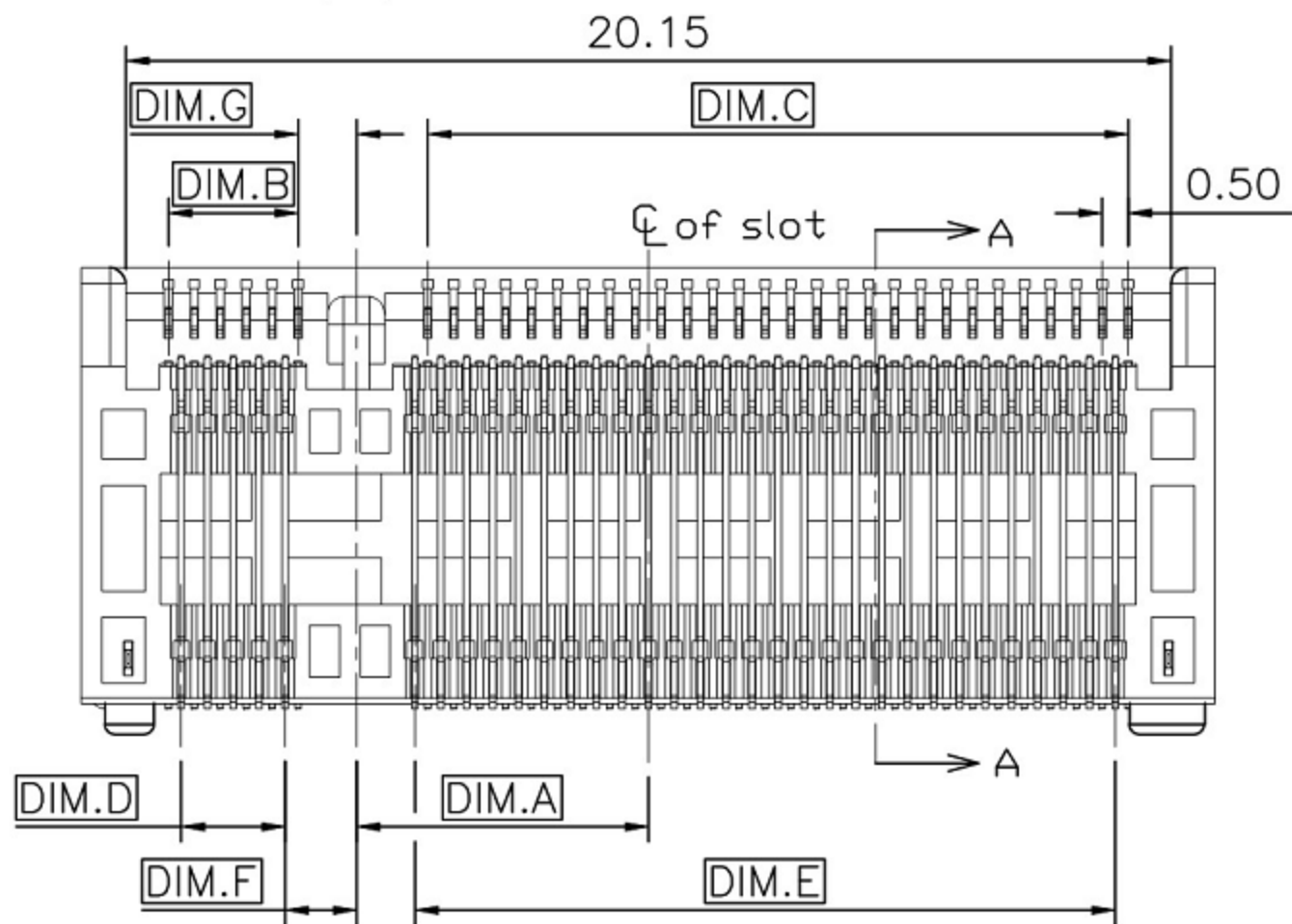
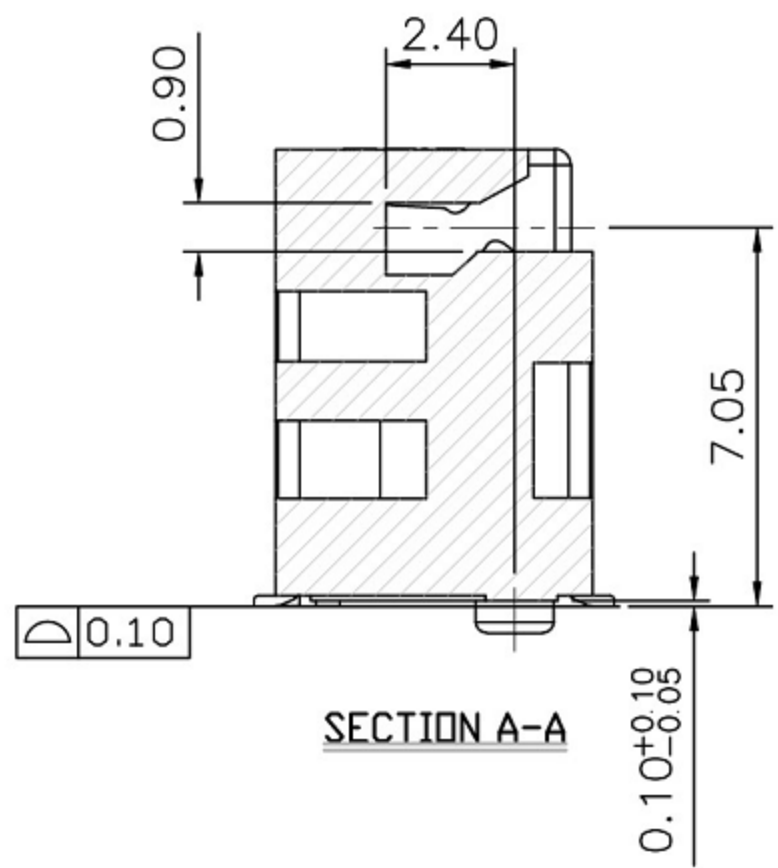
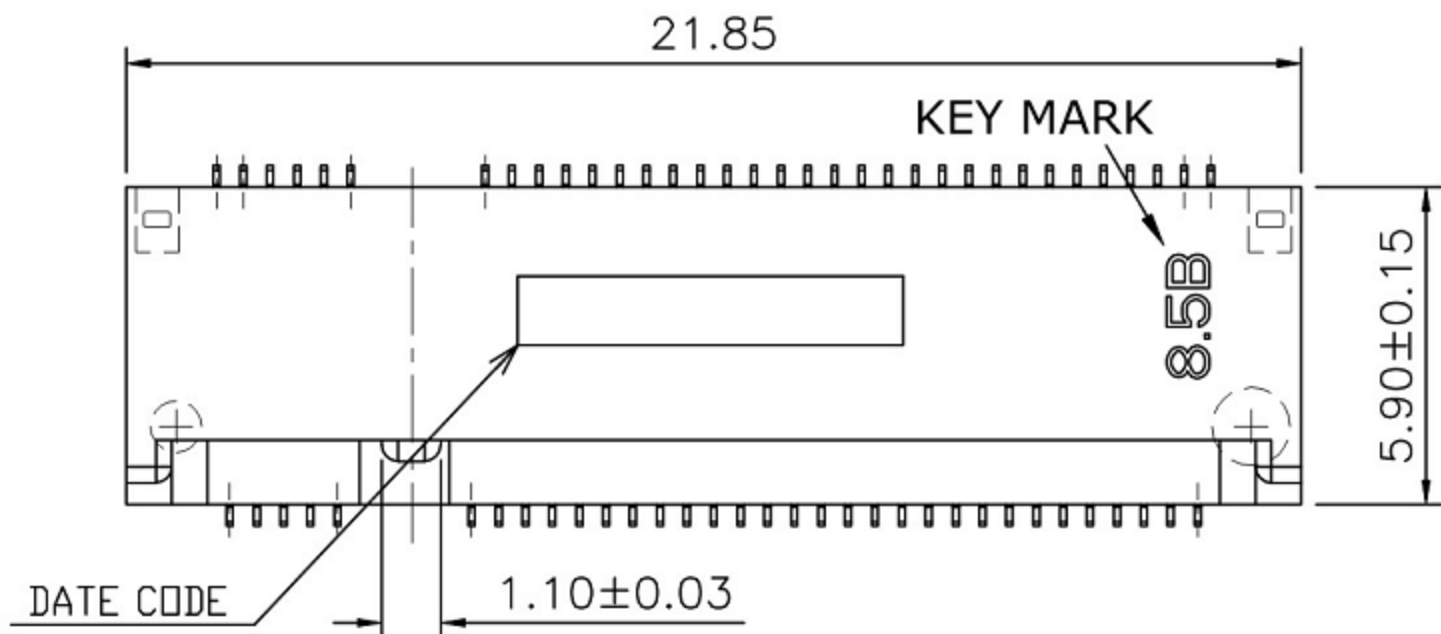


CAD FILE:

ROHS



REV.	DESCRIPTION	DRAWN	DATE
2	Add A & E Key SPEC.	FROS	2018/10/09
3	CORRECTED	TIM	2019/06/10
3.1	CORRECTED	TIM	2019/12/11

Notes:

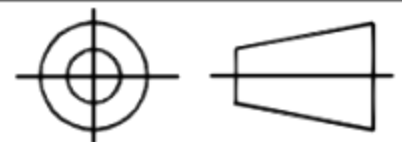
Material:

- Housing: High Temperature Thermoplastic, UL94V-0, Black
- Contacts: Copper Alloy, gold plated on contact area and gold flash solder area. 50u" min nickel under-plating overall.
- △ Peg: Copper Alloy, 50~120u" min matte-tin plated on soldering area. 50u" min. nickel under-plating.
- Reflow Solder Capable to 260°C
- Datecode: YYWWD
- How to order:

123A - 85 X A 0
M.2 Connector Height Key Color Contact plating

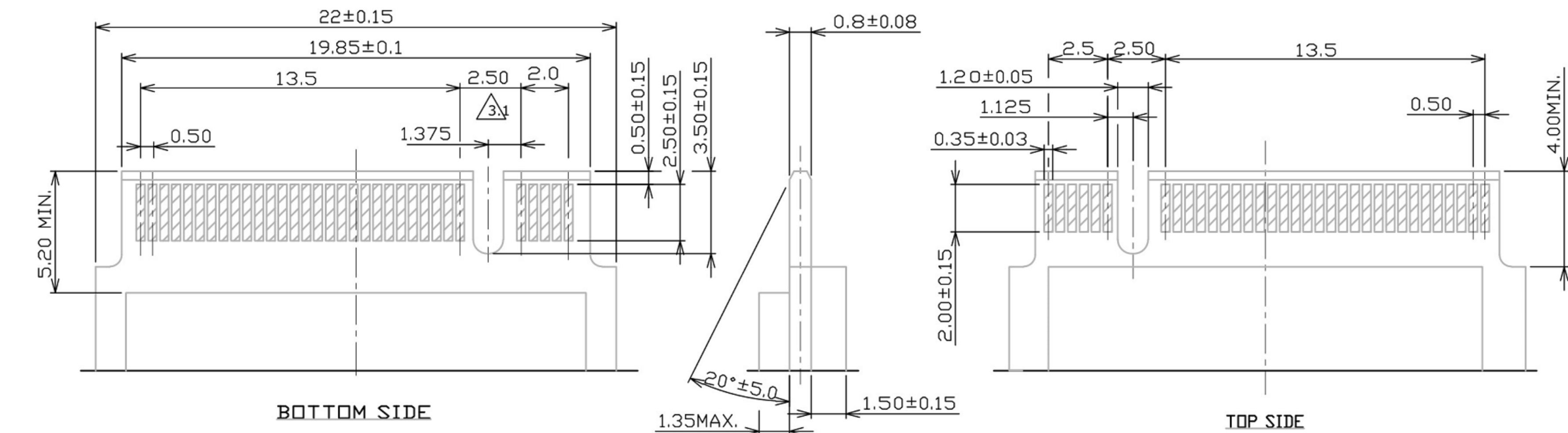
		DIMENSION TABLE							
123A-85MA0	M	-6.125	14.0	2.0	14.0	1.5	1.125	1.375	
123A-85EA0	E	2.625	5.5	10.5	5.0	10.5	1.375	1.125	
123A-85BA0	B	5.625	2.5	13.5	2.0	13.5	1.375	1.125	
123A-85AA0	A	6.625	1.5	14.5	1.0	14.5	1.125	1.375	
P/N	Key	DIM.A	DIM.B	DIM.C	DIM.D	DIM.E	DIM.F	DIM.G	

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-85BA0_B_3.1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					

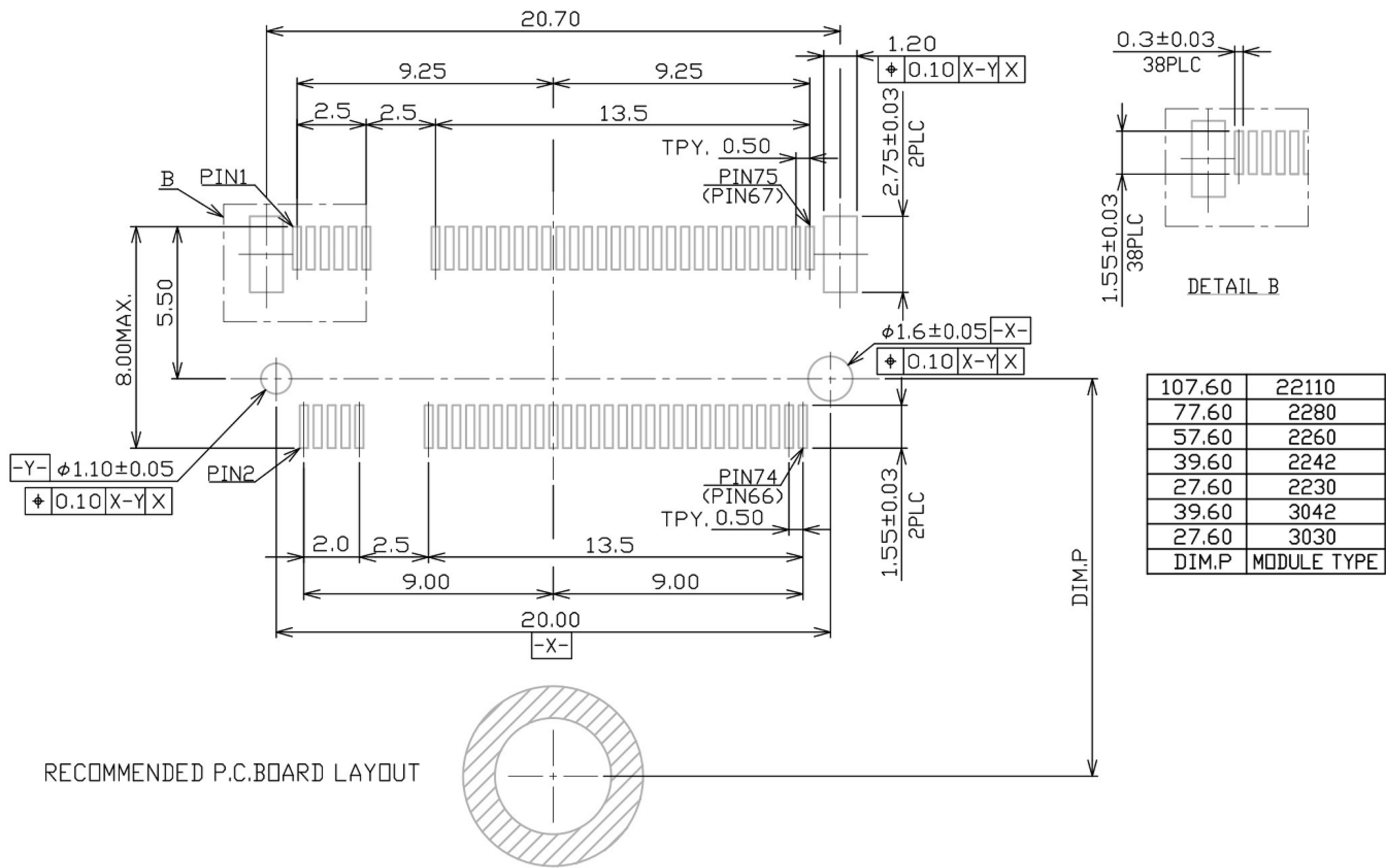


CAD FILE:

ROHS

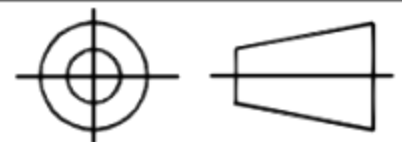


REV.	DESCRIPTION	DRAWN	DATE
	see sheet one		



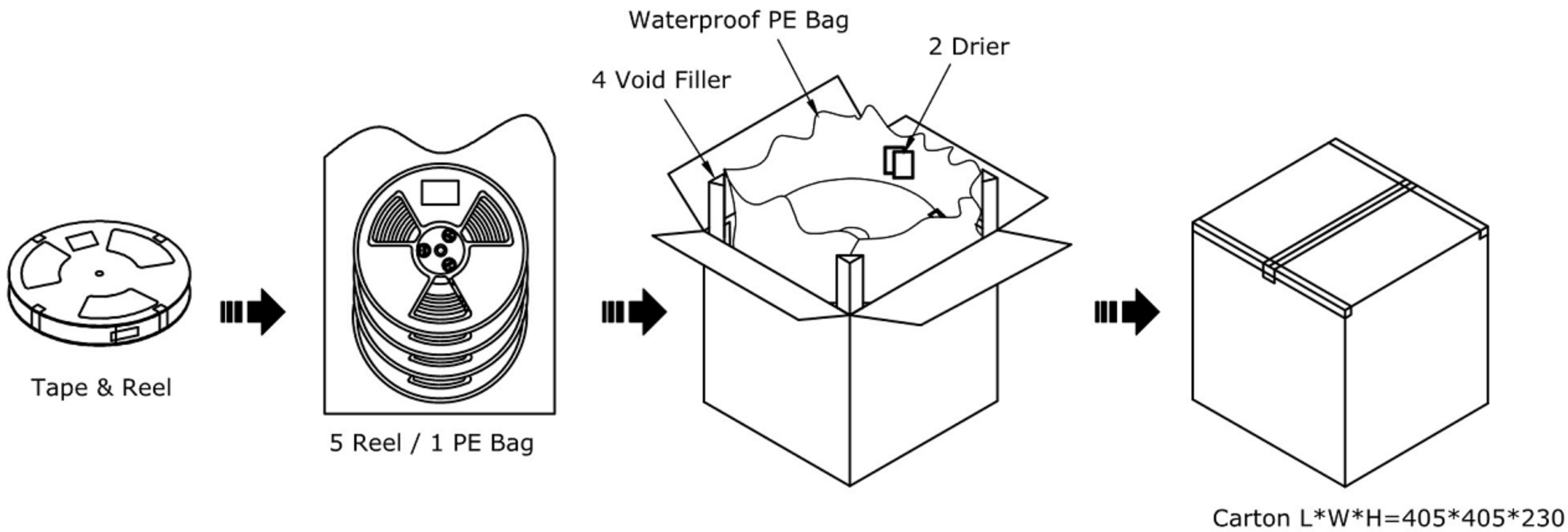
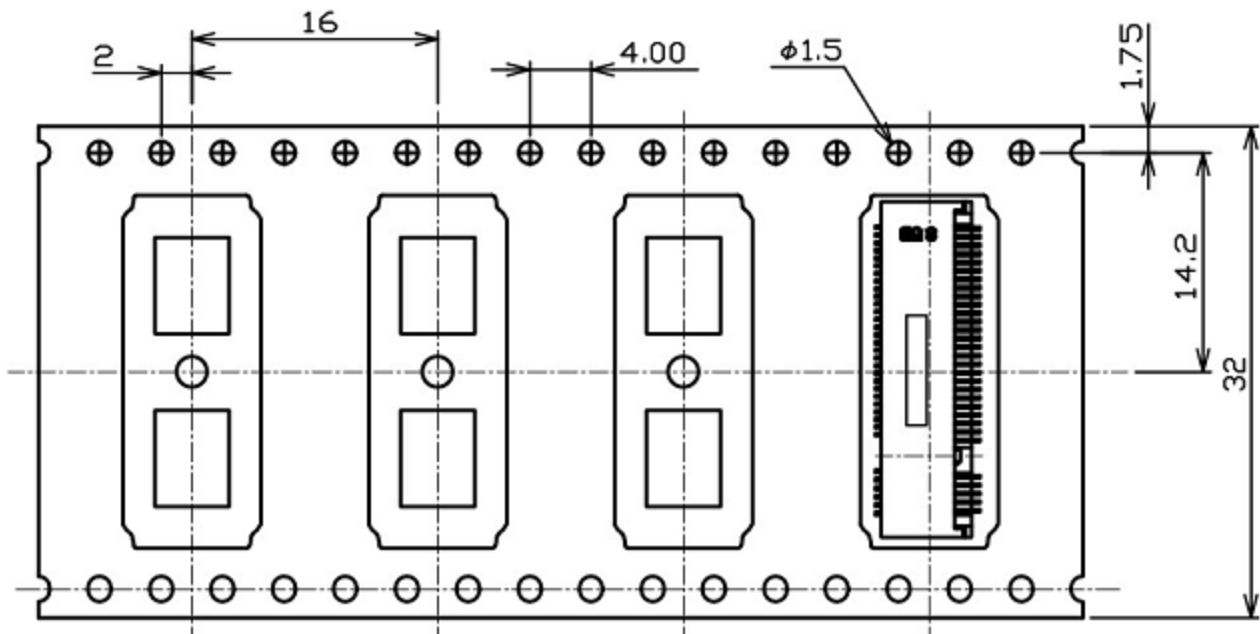
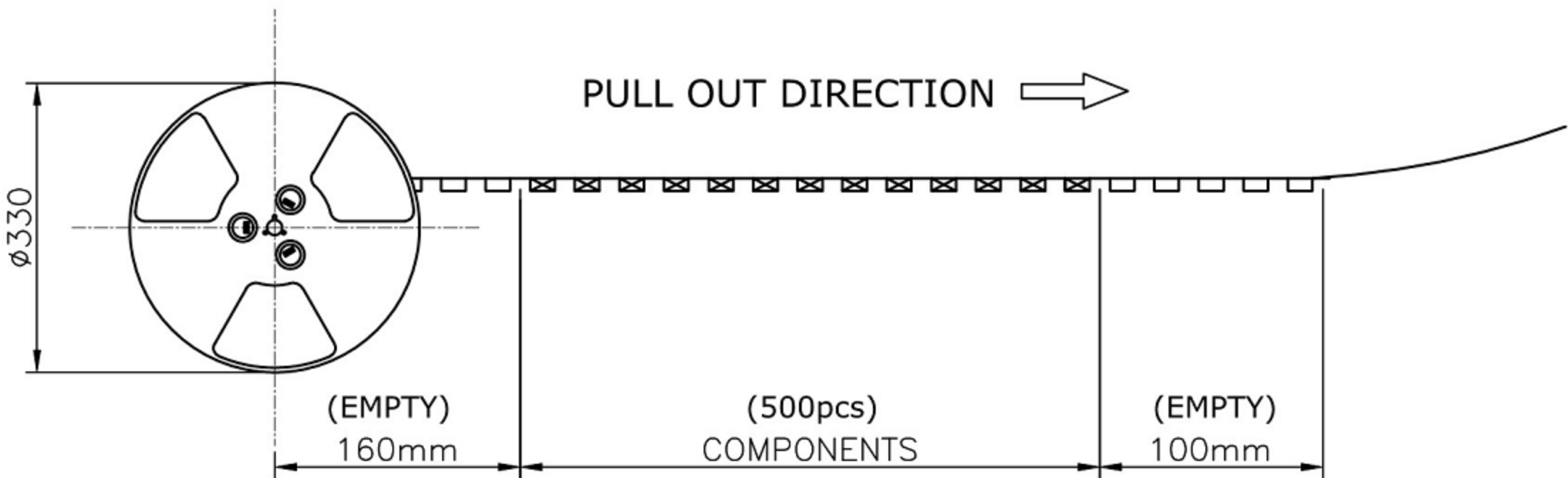
107.60	22110
77.60	2280
57.60	2260
39.60	2242
27.60	2230
39.60	3042
27.60	3030
DIM.P	MODULE TYPE

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-85BA0_B_3.1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			CHK'D DONG. PANG 2012-9-25	
1	KNOB	PPA	1	BLACK				APPD. ZENQ. CHEN 2012-9-25	
NO.	PARTS	MATERIALS	Q'TY	FINISH					



CAD FILE:

ROHS



REV.	DESCRIPTION	DRAWN	DATE
	see sheet one		

PACKAGING SPECIFICATION:

Quantity:
500 Piece/ Reel
5 Reel/ Carton
2,500 Piece/ Outer Carton

8					TOLERANCE				
7					UNLESS SPECIFIED				
6					WITHIN 1.5mm : ±0.1mm	A	2012-9-25	初 版	ZENQ. CHEN
5					OVER 1.5mm : ±0.2mm	ISSUE	DATE	DESCRIPTIONS OF REVISION	APPD.
4	CONTACT	SUS	1	Ag CLAD	TITLE : PCB卡插座			UNIT : mm	DRWG NO.: XB-123A-85BA0_B_3.1
3	CASE	PPA/BRASS SRTIP	1	BLACK/Ag PLATED	MODEL: PCB Card Socket			SCALE: 5:1	DWN. JUN. YANG 2012-9-25
2	COVER	STEEL STRIP	1	Ni PLATED	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD.			CHK'D	DONG. PANG 2012-9-25
1	KNOB	PPA	1	BLACK				APPD.	ZENQ. CHEN 2012-9-25
NO.	PARTS	MATERIALS	Q'TY	FINISH					